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**OFFICE OF PETITIONS**

Applicant: Itakura et al.  
Appl. No.: 10/709,305  
Filing Date: April 28, 2004  
Title: SOLDER FILM MANUFACTURING METHOD, HEAT SINK FURNISHED WITH  
SOLDER FILM, AND SEMICONDUCTOR-DEVICE-AND-HEAT-SINK JUNCTION  
Attorney Docket No.: 39.036  
Pub. No.: US 2005/0089700 A1  
Pub. Date: April 28, 2005

This is a decision on the request for a corrected patent application publication under  
37 CFR 1.221(b), filed on June 28, 2005, for the above-identified application.

The request is granted.

The corrected patent application publication will be published in due course, unless the patent  
issues before the application is republished.

Inquiries relating to this matter may be directed to Mark Polutta at (571) 272-7709 (voice).

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Office of Patent Legal Administration  
Office of the Deputy Commissioner  
for Patent Examination Policy